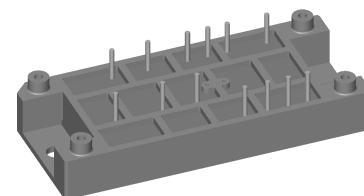
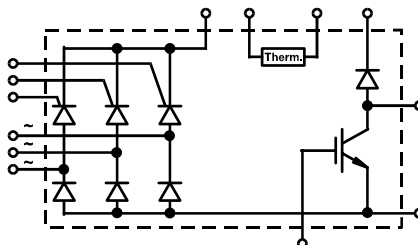


Three Phase Half Controlled Rectifier Bridge with IGBT and Fast Recovery Diode for Braking System

V_{RRM} = 1200-1600 V
I_{dAV} = 120 A

V _{RRM} V	Type
1200	VVZB 120-12 io1
1400	VVZB 120-14 io1
1600	VVZB 120-16 io1



Symbol	Conditions	Maximum Ratings	
I _{dAV}	T _{case} = 80°C, sinusoidal 120°	120	A
I _{FRMS} /I _{TRMS}	T _{case} = 80°C, per leg	77	A
I _{FSM} /I _{TSM}	T _{VJ} = 25°C, t = 10 ms, V _R = 0 V	750	A
	T _{VJ} = 150°C, t = 10 ms, V _R = 0 V	670	A
I ² t	T _{VJ} = 25°C, t = 10 ms, V _R = 0 V	2810	A
	T _{VJ} = 150°C, t = 10 ms, V _R = 0V	2240	A
(di/dt) _{cr}	T _{VJ} = T _{VJM} repetitive, I _T = 150 A f = 50 Hz, t _p = 200 μs	150	A/μs
	V _D = 2/3 V _{DRM} I _G = 0.45 A, non repetitive, I _T = I _{d(AV)} /3 di _G /dt = 0.45 A/μs	500	A/μs
(dv/dt) _{cr}	T _{VJ} = T _{VJM} ; V _{DR} = 2/3 V _{DRM} R _{GK} = ∞; method 1 (linear voltage rise)	1000	V/μs
P _{GM}	T _{VJ} = T _{VJM} t _p = 30 μs	10	W
	I _T = I _{d(AV)} /3 t _p = 300 μs	5	W
	t _p = 10 ms	1	W
P _{GAVM}		0.5	W
V _{CES}	T _{VJ} = 25°C to 150°C	1200	V
V _{GE}	Continuous	± 20	V
I _{C25}	T _{case} = 25°C, DC	78	A
I _{C80}	T _{case} = 80°C, DC	52	A
I _{CM}	t _p = Pulse width limited by T _{VJM}	140	A
P _{tot}	T _{case} = 80°C	222	W
V _{RRM}		1200	V
I _{F(AV)}	T _{case} = 80°C, rectangular d = 0.5	27	A
	T _{case} = 80°C, rectangular d = 0.5	38	A
	T _{case} = 80°C, t _p = 10 μs, f = 5 kHz	tbd	A
I _{FSM}	T _{VJ} = 45°C, t = 10 ms	200	A
	T _{VJ} = 150°C, t = 10 ms	180	A
P _{tot}	T _{case} = 80°C	64	W

Features

- Soldering connections for PCB mounting
- Isolation voltage 3600 V~
- Ultrafast freewheel diode
- Convenient package outline

Applications

- Drive Inverters with brake system

Advantages

- 2 functions in one package
- No external isolation
- Easy to mount with two screws
- Suitable for wave soldering
- High temperature and power cycling capability

Data according to IEC 60747
 IXYS reserves the right to change limits, test conditions and dimensions.

Symbol	Conditions	Characteristic Values ($T_{VJ} = 25^{\circ}\text{C}$, unless otherwise specified)		
		min.	typ.	max.
I_R, I_D	$V_R = V_{RRM}/V_{DRM}$ $V_R = V_{RRM}/V_{DRM}, T_{VJ} = 150^{\circ}\text{C}$			0.3 mA 5 mA
V_F, V_T	$I_F = 100 \text{ A}$,			1.47 V
V_{T0}	For power-loss calculations only			0.85 V
r_T	$T_{VJ} = 150^{\circ}\text{C}$			5 m Ω
V_{GT}	$V_D = 6 \text{ V}; T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = -40^{\circ}\text{C}$			1.5 V 1.6 V
I_{GT}	$V_D = 6 \text{ V}; T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = -40^{\circ}\text{C}$			100 mA 200 mA
V_{GD}	$T_{VJ} = T_{VJM}; V_D = 2/3 V_{DRM}$			0.2 V
I_{GD}		$T_{VJ} = T_{VJM}; V_D = 2/3 V_{DRM}$		
I_L	$V_D = 6 \text{ V}; t_G = 30 \mu\text{s}$ $di_G/dt = 0.45 \text{ A}/\mu\text{s}; I_G = 0.45 \text{ A}$			450 mA
I_H		$T_{VJ} = T_{VJM}; V_D = 6 \text{ V}; R_{GK} = \infty$		
t_{gd}	$V_D = 1/2 V_{DRM}$ $di_G/dt = 0.45 \text{ A}/\mu\text{s}; I_G = 0.45 \text{ A}$			2 μs
t_q	$T_{VJ} = T_{VJM}; V_R = 100 \text{ V}; V_D = 2/3 V_{DRM}; t_p = 200 \mu\text{s}$ $dv/dt = 10 \text{ V}/\mu\text{s}; I_T = 120 \text{ A}; -di/dt = 10 \text{ A}/\mu\text{s}$			150 μs
Q_S	$T_{VJ} = T_{VJM}$ $-di/dt = 0.64 \text{ A}/\mu\text{s}; I_T/I_F = 50 \text{ A}$			90 μC
I_{RM}				11 A
R_{thJC}	per thyristor / diode; sine 120° el.			1 KW
R_{thJH}	per thyristor / diode; sine 120° el.			1.3 KW
$V_{BR(CES)}$	$V_{GS} = 0 \text{ V}, I_C = 1 \text{ mA}$	1200		V
$V_{GE(th)}$	$I_C = 10 \text{ mA}$	5		8 V
I_{GES}	$V_{GE} = \pm 20 \text{ V}$			500 nA
I_{CES}	$V_{CE} = 0.8 V_{CES}$ $V_{CE} = 0.8 V_{CES}, T_{VJ} = 150^{\circ}\text{C}$			0.5 mA 3 mA
V_{CESat}	$V_{GE} = 15 \text{ V}, I_C = 50 \text{ A}$			3.35 V
t_{sc} (SCSOA)	$V_{GE} = 15 \text{ V}, V_{CE} = 0.6 V_{CES}, T_{VJ} = 125^{\circ}\text{C}$, $R_G = 11 \Omega$, non repetitive			10 μs
RBSOA	$V_{GE} = 15 \text{ V}, V_{CE} = 0.8 V_{CES}, T_{VJ} = 125^{\circ}\text{C}$, $R_G = 11 \Omega$, Clamped Inductive load, $L = 100 \mu\text{H}$			100 A
C_{ies}		$V_{CE} = 25 \text{ V}, f = 1 \text{ MHz}, V_{GE} = 0 \text{ V}$	9	
$t_{d(on)}$	$V_{CE} = 0.6 V_{CES}, I_C = 25 \text{ A}$ $V_{GE} = 15 \text{ V}, R_G = 11 \Omega$ Inductive load; $L = 100 \mu\text{H}$ $T_{VJ} = 125^{\circ}\text{C}$		65	ns
$t_{d(off)}$			200	ns
t_{ri}			tbd	ns
t_{fi}			tbd	ns
E_{on}			4.1	mJ
E_{off}			5.7	mJ
R_{thJC}				0.32 KW
R_{thJH}				0.45 KW

Symbol	Conditions	Characteristic Values		
		(T _{VJ} = 25°C, unless otherwise specified)		
		min.	typ.	max.
I _R	V _R = V _{RRM} , T _{VJ} = 25°C			0.75 mA
	V _R = 0.8 V _{RRM} , T _{VJ} = 150°C		3	7 mA
V _F	I _F = 30 A, T _{VJ} = 25°C			2.55 V
V _{T0}	For power-loss calculations only			1.65 V
r _T	T _{VJ} = 150°C			18.2 mΩ
I _{RM}	I _F = 30 A, -di _F /dt = 240 A/μs V _R = 100 V		16	18 A
t _{rr}	I _F = 1 A, -di _F /dt = 100 A/μs V _R = 30 V		40	60 ns
R _{thJC}				1.1 KW
R _{thJH}				1.5 KW
Fast Recovery Diode				
Common Specification		Maximum Ratings		
T _{VJ}		-40...+150		°C
T _{VJM}			150	°C
T _{stg}		-40...+125		°C
V _{ISOL}	50/60 Hz	t = 1 min	3000	V~
	I _{ISOL} ≤ 1 mA	t = 1 s	3600	V~
M _d	Mounting torque (M5) (10-32 unf)		2-2.5 18-22	Nm lb.in.
Weight	typ.		80	g
d _s	Creep distance on surface		12.7	mm
d _A	Strike distance in air		11	mm
a	Maximum allowable acceleration		50	m/s ²
R ₂₅	Thermistor		2.1	kΩ
B _{25/100}			3560	K
Module				

